

## Electronic Patent Application Fee Transmittal

Application Number:	10786825			
Filing Date:	25-Feb-2004			
Title of Invention:	Manufacture of mountable capped chips			
First Named Inventor/Applicant Name:	Belgacem Haba			
Filer:	Dennis M. Smid			
Attorney Docket Number:	TESSERA 3.0-337 II			
Filed as Large Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>180</b>